

Data Sheet

Customer: _____

Product: Hybrid Conductive Polymer Capacitors SMD Type

Endurance 105°C 5,000Hours – AEMSS Series

AEC-Q200 version available

Size : 6.3x5.8mm ~ 10x12.7mm _____

Issued Date: 16-Oct-2023 _____

Edition: Ver. 1 _____

Record of change

Date	Ver.	Description	Page
16-Oct-2023	1		

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Prepared by	Checked by	Approved by	Accepted by (customer)
16-Oct-2023	16-Oct-2023	16-Oct-2023	
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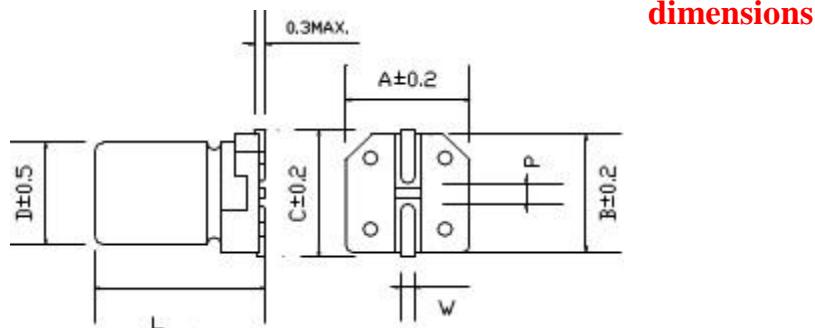
Features

- SMD TYPE. **Hybrid** Conductive Polymer Aluminum Solid Capacitors
- This type has lowest ESR level and excellent performance at high frequency through low profile.
- Ideal capacitor for digital and high frequency devices.
- Load life 105°C **5,000** hours assured.
- AEC-Q200 version available

Characteristics

Voltage Range	16 ~100VDC	
Capacitance Range	10uF ~ 1000uF	
Temperature Range	-55 ~ +105°C	
Capacitance Tolerance	M=+20%/-20% , K=+10%/-10% (at 20°C, 120Hz)	
Leakage Current	Capacitance(μF) x Rated Voltage(Vdc) After 2minutes, see standard rating	
Dissipation Factor (tanδ) 20°C 120Hz	See standard rating	
ESR (at 100K~300K Hz, 20°C)	See standard rating	
Endurance (Rated Voltage at 105°C 5,000h, restored to 20°C)	Appearance	≤ No significant damage
	Capacitance Change (μF)	Within ±20% of initial measured value
	Dissipation Factor (tanδ)	≤ 150% of an initial specified value
	ESR (mΩ)	≤ 150% of an initial specified value
	Leakage Current (μA)	≤ Initial specified value
Moisture Resistance (Test at 60°C, 90~95RH for 1000hrs, L.C. should be tested after voltage treatment)	Capacitance Change (μF)	Within ±20% of initial measured value
	Dissipation Factor (tanδ)	≤ 150% of an initial specified value
	ESR (mΩ)	≤ 150% of an initial specified value
	Leakage Current (μA)	≤ Initial specified value
Resistance to Soldering Heat	Capacitance Change (μF)	Within ±10% of initial measured value
	Dissipation Factor (tanδ)	≤ 130% of an initial specified value
	ESR (mΩ)	≤ 130% of an initial specified value
	Leakage Current (μA)	≤ Initial specified value

Diagram of



Lead Spacing And Diameter

Case Size	ϕD	L	A	B	C	W	P±0.2
C6	6.3	5.8±0.5	6.5	6.5	7.2	0.5 ~ 0.8	2.1
C8	6.3	7.7±0.5	6.5	6.5	7.2	0.5 ~ 0.8	2.1
C10	6.3	9.2±0.5	6.5	6.5	7.2	0.5 ~ 0.8	2.1
C12	6.3	11.5±0.5	6.5	6.5	7.2	0.5 ~ 0.8	2.1
D8	8	7.7±0.5	8.3	8.3	9.0	0.8 ~ 1.1	3.2
D10	8	9.4±0.5	8.3	8.3	9.0	0.8 ~ 1.1	3.2
D12	8	11.7±0.5	8.3	8.3	9.0	0.8 ~ 1.1	3.2
F11	10	10.7±0.5	10.3	10.3	11.0	0.8 ~ 1.1	4.6
F13	10	12.7±0.5	10.3	10.3	11.0	0.8 ~ 1.1	4.6

Frequency coefficient for ripple current

Frequency	120Hz≤f<1KHz	1KHz≤f<10KHz	10KHz≤f<100KHz	100KHz≤f<500KHz
Coefficient	0.05	0.3	0.7	1

Ripple Current: mA /rms at 100kHz, 105°C

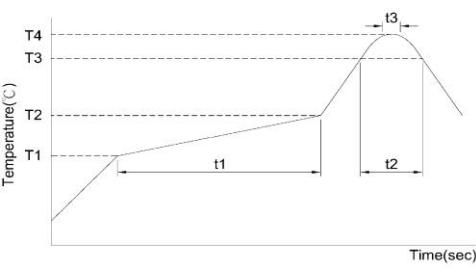
W.V.(V)	Capacitance (μ F)	Size ϕ DxL(mm)	Size Code	Tan δ (120Hz,20C)	L.C. (μ A)	E.S.R. (100k-300kHz,m Ω ,2 0°C MAX)	Rated R.C (mArms at 100kHz, 105°C)
16 V	100	6.3x5.8	C6	0.1	16	28	2300
	100	6.3x7.7	C8	0.1	16	24	2300
	270	6.3x9.2	C10	0.1	43.2	18	3000
	330	6.3x9.2	C10	0.1	53	18	3100
	470	8x9.4	D10	0.1	75.2	14	3500
	560	8x9.4	D10	0.1	89.6	14	3500
	680	8x11.7	D12	0.1	109	15	4500
	820	8x11.7	D12	0.1	131.2	12	4500
	1000	10x12.7	F13	0.1	160	14	4800
25V	100	6.3x5.8	C6	0.1	25	26	2000
	100	6.3x9.2	C10	0.1	25	24	2000
	220	6.3x9.2	C10	0.1	55	22	2200
	330	8x9.2	D10	0.1	82	20	3200
	470	8x11.7	D12	0.1	117.5	16	4200
	560	8x11.7	D12	0.1	140	16	4500
	680	10x12.7	F13	0.1	170	14	5000
	100	6.3x9.2	C10	0.1	35	30	2000
35V	220	8x11.7	D12	0.1	77	24	2500
	330	10x12.7	F13	0.1	115.5	18	3200
	470	10x12.7	F13	0.1	164.5	16	3500
	22	6.3x5.8	C6	0.1	11	40	1800
50V	33	6.3x9.2	C10	0.1	17	36	2000
	47	6.3x9.2	C10	0.1	24	35	2200
	56	6.3x11.5	C12	0.1	28	25	2400
	68	6.3x11.5	C12	0.1	34	22	2500
	68	8x9.4	D10	0.1	34	22	3300
	82	8x11.5	D12	0.1	41	20	3800
	100	8x11.7	D12	0.1	50	20	4000
	150	10x12.7	F13	0.1	75	20	3200
	220	10x12.7	F13	0.1	110	20	3200
	10	6.3x5.8	C6	0.1	10	45	1800
63v	10	6.3x9.2	C10	0.1	10	35	2000
	22	6.3x9.2	C10	0.1	13.86	35	2200
	33	6.3x11.5	C12	0.1	20.79	30	2500
	47	8x9.4	D10	0.1	29.61	22	2400
	56	8x11.7	D12	0.1	35.28	22	2700
	82	10x12.7	F13	0.1	51.66	18	3000
	100	10x12.7	F13	0.1	63	16	3500
	22	8x9.4	D10	0.1	17.6	28	2400
80v	47	8x11.7	D12	0.1	37.6	24	2800
	56	10x12.7	F13	0.1	44.8	25	2500
	68	10x12.7	F13	0.1	54	23	3300
	12	6.3x9.2	C10	0.1	12	35	2000
100v (2A)	15	8x9.4	D10	0.1	15	32	2200
	22	8x11.7	D12	0.1	22	28	2400
	33	8x11.7	D12	0.1	33	26	2400
	47	10x12.7	F13	0.1	47	25	3000
	56	10x12.7	F13	0.1	56	23	3200

Reliability for Car- Tronics

AEC Q-200_REV D

Endurance Characteristic:

No.	Item	Conditions	Specification		Reference
1	High Temperature Load Life Test	Capacitor is placed in the highest temperature with rated voltage for 5000+72/-0Hrs.	Capacitance change	Within ±30% of initial value	MIL-STD-202 Method 108
			Tanδ	Less than 300% of specified value	
			Leakage Current	Within specified value	
			Appearance	No abnormality	
2	High Temperature Exposure (Storage)	Capacitor is placed in the highest temperature for 1000+48/-0Hrs.	Capacitance change	Within ±30% of initial value	MIL-STD-202 Method 108
			Tanδ	Less than 300% of specified value	
			Leakage Current	Within specified value	
			Appearance	No abnormality	
3	Temperature Cycling	Step1: Max. rated temperature±3/-3°C(30±3mins) Step2: Min. rated temperature±3/-3°C(30±3mins) Max.transfer time: 1min According to the step1 to step2, and do 1000cycles	Capacitance change	Within ±10% of initial value	JESD22 Method JA-104
			Tan δ	Within specified value	
			Leakage Current	Within specified value	
			Appearance	No abnormality	
4	Biased Humidity	Capacitor is placed at the temperature of 85±3°C, and humidity of 85% with rated voltage for 1000Hrs	Capacitance change	Within ±20% of initial value	MIL-STD-202 Method 103
			Tanδ	Less than 150% of specified value	
			Leakage Current	Within specified value	
			Appearance	No abnormality	
5	Physical Dimension		Appearance	No abnormality	JESD22 Method JB-100
6	Resistance To Solvent	1.The capacitor shall be immersed into the isopropyl. 2.Immersion time: 3 +0.5/-0 minutes at 25±5°C. 3.Use wool brush to brush capacitor for 10 times. Conduct the steps 1~3 for 3 cycles.	Print cannot fall off or ambiguous		MIL-STD-202 Method 215
7	Mechanical Shock	Capacitor is placed on the PCB and fixed.Conditions as below:	Capacitance change	Within ±10% of initial value	MIL-STD-202 Method 213
		Test items For automobile	Tanδ	Within specified value	
		Acceleration speed 100g(1000 m/s ²)	Leakage Current	Within specified value	
		Shocking direction X-Y-Z three axles (6 planes)			
		Duration(D)(ms) 6			
		Velocity(m/s) 3.75			
		Wave Half sine			
8	Vibration	Capacitor is placed in the PCB and fixed. Setting the acceleration (5g)and frequency (10-2000Hz) according to the test condition ,vibration 4Hrs from three directions (X-Y-Z).	Capacitance change	Within ±10% of initial value	MIL-STD-202 Method 204
				Within specified value	
				Within specified value	
				No abnormality	
			Appearance	No abnormality	

No.	Item	Conditions	Specification		Reference																																							
9	Resistance to Soldering Heat	According to the Control standard operating of Jarson, test twice. 	Capacitance change	Within ±10% of initial value	MIL-ST D- 202 Method 210																																							
		Tanδ	Within specified value																																									
		Leakage Current	Within specified value																																									
		Appearance	No abnormality																																									
		<table border="1"> <thead> <tr> <th>Rated voltage (V)</th> <th>4~50</th> <th>63 up</th> <th>4~100</th> </tr> </thead> <tbody> <tr> <td>Case size (φ)</td> <td>4~6.3</td> <td>4~6.3</td> <td>8~12.5</td> </tr> </tbody> </table>			Rated voltage (V)	4~50	63 up	4~100	Case size (φ)	4~6.3	4~6.3	8~12.5																																
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10	Solderability test (SMD)	Solderability test 1: Solder bath temperature: 235±5°C Duration:5±0/-0.5s Solderability test 2:Solder bath temperature:260±5°C Duration:7±0.5s	Sn is more than 95% in the surface of terminal		J-STD-002B																																							
11	Electrical Characterization	Whether there is abnormality about electrical characterization in the test that under the ensurance temperature(the lowest ,the highest, atmospheric temperature).	Appearance: No abnormality		User Spec.																																							
12	Board Flex	Capacitor is placed in the PCB and pressed to deviate from Original fulcrum more than 2mm for 60 (+5) s.	Capacitance change	Within ±10% of initial value	AEC-Q 200-005																																							
			Tanδ	Within specified value																																								
			Leakage Current	Within specified value																																								
			Appearance	No abnormality																																								
13	Terminal Strength (SMD)	Test condition: Capacitor is placed in the PCB by solder paste and do high temperature test (Reflow) to endurance the power of 1.8kg for 60S,no dropping condition.	Capacitance change	Within ±10% of initial value	AEC-Q 200-006																																							
			Tanδ	Within specified value																																								
			Leakage Current	Within specified value																																								
			Appearance	No abnormality																																								
14	Surge Voltage	Capacitor is placed at 15°C~35°C with surge voltage for 30±5(charging) and 330s(discharging),do surge voltage test continuity for 1000 times. Applying voltage: <table border="1"><tr><td>W.V.</td><td>6.3</td><td>10</td><td>16</td><td>25</td><td>35</td><td>50</td><td>63</td></tr><tr><td>S. V.</td><td>7.3</td><td>11.5</td><td>18.4</td><td>28.8</td><td>40.3</td><td>57.5</td><td>72.5</td></tr><tr><td>W.V.</td><td>80</td><td>100</td><td>160</td><td>200</td><td>250</td><td>400</td><td>450</td></tr><tr><td>S. V.</td><td>92</td><td>115</td><td>184</td><td>230</td><td>288</td><td>440</td><td>495</td></tr></table>	W.V.	6.3	10	16	25	35	50	63	S. V.	7.3	11.5	18.4	28.8	40.3	57.5	72.5	W.V.	80	100	160	200	250	400	450	S. V.	92	115	184	230	288	440	495	Capacitance change	Within ±20% of initial value	AEC-Q 200-007							
W.V.	6.3	10	16	25	35	50	63																																					
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W.V.	80	100	160	200	250	400	450																																					
S. V.	92	115	184	230	288	440	495																																					
Tanδ	Less than 175% of specified value																																											
Leakage Current	Within specified value																																											
Appearance	No abnormality																																											